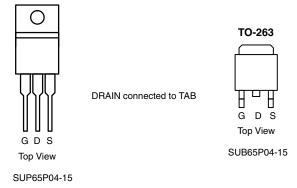


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P-Channel 40 V (D-S) 175 °C MOSFET

PRODUC	T SUMMARY				
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)			
- 40	0.015 at V _{GS} = - 10 V	- 65			
- 40	0.023 at V _{GS} = - 4.5 V	- 50			

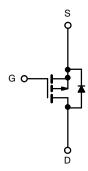


Ordering Information: SUP65P04-15-E3 (Lead (Pb)-free)

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- TrenchFET[®] Power MOSFET
- Compliant to RoHS Directive 2002/95/EC





P-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	- 40	v		
Gate-Source Voltage	V _{GS}	± 20	v		
Continuous Drain Current ($T_1 = 175 ^{\circ}C$)	T _C = 25 °C	1_	- 65	٨	
	T _C = 125 °C	D	- 37		
Pulsed Drain Current	I _{DM}	- 240	A		
Avalanche Current	I _{AR}	- 60	1		
Repetitive Avalanche Energy ^a L = 0.1 mH		E _{AR}	180	mJ	
Deven Dissinguitien	T_{C} = 25 °C (TO-220AB and TO-263)	D	120 ^c	W	
Power Dissipation	T _A = 25 °C (TO-263) ^b	P _D -	3.75		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Limit	Unit	
Junction-to-Ambient	PCB Mount (TO-263) ^b	R _{thJA}	40		
Sunction-to-Ambient	Free Air (TO-220AB)	R _{thJA}	62.5	°C/W	
Junction-to-Case		R _{thJC}	1.25		

Notes:

a. Duty cycle \leq 1 %.

b. When mounted on 1" square PCB (FR-4 material).

c. See SOA curve for voltage derating.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$	- 40			v	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	- 1		- 3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = -40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = - 40 V, V_{GS} = 0 V, T_{J} = 125 °C			- 50		
		V_{DS} = - 40 V, V_{GS} = 0 V, T_{J} = 175 °C			- 250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = -5 V, V_{GS} = -10 V$	- 120			А	
		V _{GS} = - 10 V, I _D = - 30 A		0.012	0.015	- Ω	
	P	V_{GS} = - 10 V, I _D = - 30 A, T _J = 125 °C			0.024		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V_{GS} = - 10 V, I _D = - 30 A, T _J = 175 °C			0.030		
		V _{GS} = - 4.5 V, I _D = - 20 A		0.018	0.023	1	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 50 A	20			S	
Dynamic ^b		· · · · · ·					
Input Capacitance	C _{iss}			5400		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$, $V_{DS} = -25 V$, f = 1 MHz		640			
Reverse Transfer Capacitance	C _{rss}			300			
Total Gate Charge ^c	Qg			85	130	nC	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = -20 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -65 \text{ A}$		25			
Gate-Drain Charge ^c	Q _{gd}			15		1	
Turn-On Delay Time ^c	t _{d(on)}			15	25		
Rise Time ^c	t _r	$V_{DD} = -20 \text{ V}, \text{ R}_{1} = 0.3 \Omega$		380	580		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong -65 \text{ A}, V_{GEN} = -10 \text{ V}, \text{ R}_{G} = 2.5 \Omega$		75	115	ns	
Fall Time ^c	t _f			140	210	1	
Source-Drain Diode Ratings and Cha	aracteristics ((T _C = 25 °C) ^b					
Continuous Current	ا _S				- 65		
Pulsed Current	I _{SM}				- 240	A	
Forward Voltage ^a	V _{SD}	I _F = - 65 A, V _{GS} = 0 V		- 1.2	- 1.5	V	
Reverse Recovery Time	t _{rr}			40	80	ns	
Peak Reverse Recovery Charge	I _{RM(REC)}	I _F = - 65 A, dl/dt = 100 A/μs		2	4	Α	
Reverse Recovery Charge	Q _{rr}	1		0.04	0.1	μC	

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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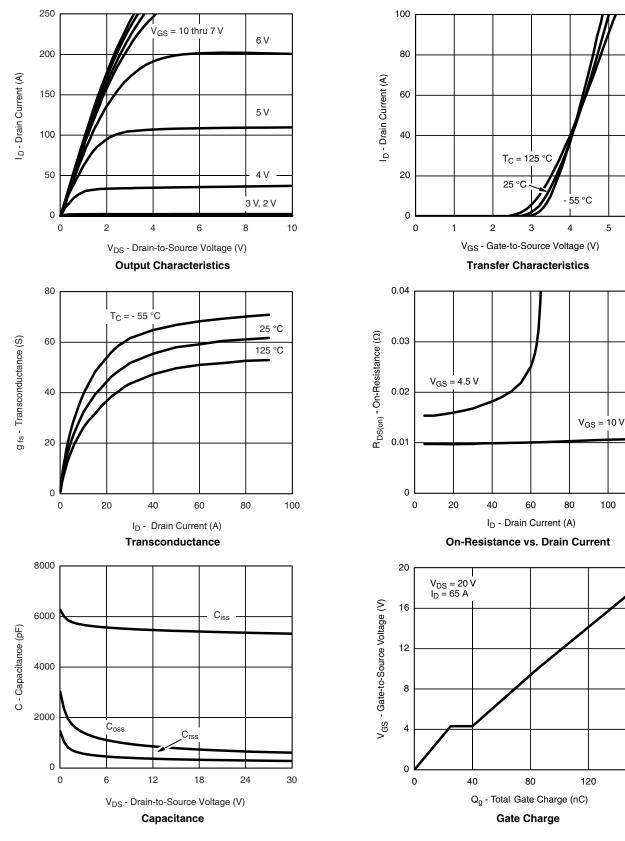
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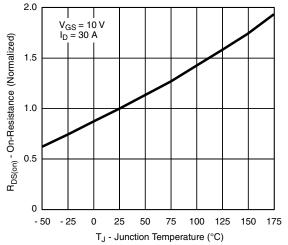
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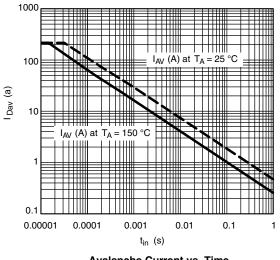
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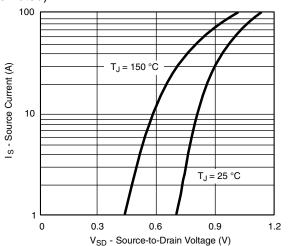
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



On-Resistance vs. Junction Temperature

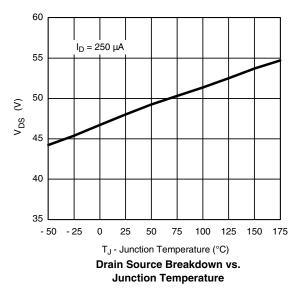


Avalanche Current vs. Time



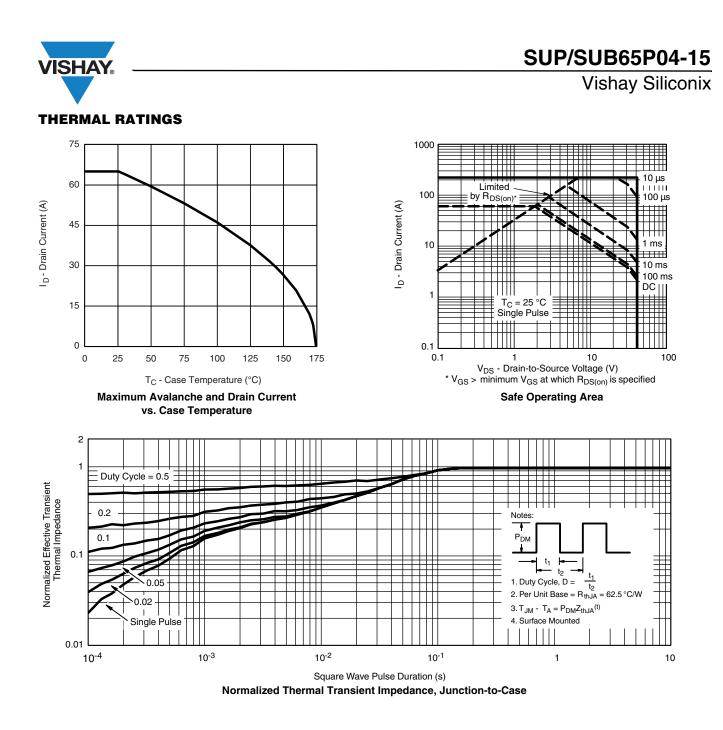
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Source-Drain Diode Forward Voltage



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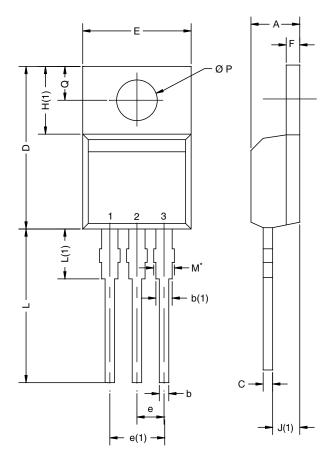


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TO-220AB



	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
E	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØР	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
ECN: T13- DWG: 547	0724-Rev. O, 1	14-Oct-13			

Note

* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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